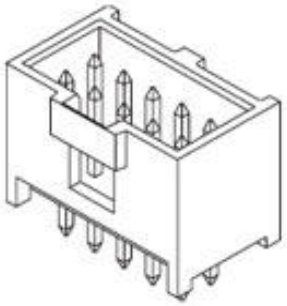
Part Number : 901301334
Product Description : C-Grid III Header, Dual Row, Vertical, Shrouded, Fully Loaded, 34 Circuits, Black, 0.76µm Gold (Au) Selective Plating
Series Number : 90130
Status : Active
Product Category : PCB Headers and Receptacles



Documents and Resources

Drawings

901301334_sd.pdf

PK-91814-005-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

901190001-AS-000.pdf

PK-90130-001-001.pdf

PS-99020-0001-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per ED/71/2019 (16 July 2019)

EU RoHS	Compliant per EU 2015/863

Compliance Statements
- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents
- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest
- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	90130
Description	C-Grid III Header, Dual Row, Vertical, Shrouded, Fully Loaded, 34 Circuits, Black, 0.76µm Gold (Au) Selective Plating
Application	Signal, Wire-to-Board
Component Type	PCB Header
Product Name	C-Grid III
UPC	800753696549

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	3.0A

Voltage - Maximum	350V AC/DC

Physical

Breakaway	No
Circuits (Loaded)	34
Circuits (maximum)	34
Color - Resin	Black
Durability (mating cycles max)	200
First Mate / Last Break	No
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	No
Lock to Mating Part	Yes
Material - Metal	Brass
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Polyester
Net Weight	3.639/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PCB Locator	No
PCB Retention	No
PCB Thickness - Recommended	1.60mm
PC Tail Length	2.90mm
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	0.762µm
Plating min - Termination	3.048µm
Polarized to Mating Part	Yes
Polarized to PCB	No
Shrouded	Closed Ends
Stackable	No
Temperature Range - Operating	-55° to +125°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	3
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	235

Mates With / Use With

Mates with Part(s)

Description	Part Number
C-Grid III Dual Row Crimp Housings	90142
C-Grid III Modular Dual Row Crimp Housings	90143